

# Power management, Dual-chip Bipolar Transistor

## EMF33

### ●Applications

Power management circuit

### ●Features

- 1) DTB513Z (digital transistor) and 2SK3019 (MOS FET) are housed independently in the EMT6 package.
- 2) Power switching circuit in a single package.
- 3) Mounting cost and area can be cut in half.

### ●Structure

Epitaxial Planar Silicon Transistor

### ●Packaging specifications

Type	Package	Taping
	Code	T2R
	Basic ordering unit (pieces)	8000
EMF33		○

### ●Absolute maximum ratings (Ta=25°C)

<Tr1>

Parameter	Symbol	Limits	Unit
Supply voltage	$V_{CC}$	-12	V
Input voltage	$V_{IN}$	-10 to +5	V
Collector current	$I_{C(max)}$ *	-500	mA

\* Characteristics of built-in transistor.

<Tr2>

Parameter	Symbol	Limits	Unit	
Drain-source voltage	$V_{DSS}$	30	V	
Gate-source voltage	$V_{GSS}$	±20	V	
Drain current	Continuous	$I_D$	100	mA
	Pulsed	$I_{DP}$ *	200	mA
Reverse drain current	Continuous	$I_{DR}$	100	mA
	Pulsed	$I_{DRP}$ *	200	mA

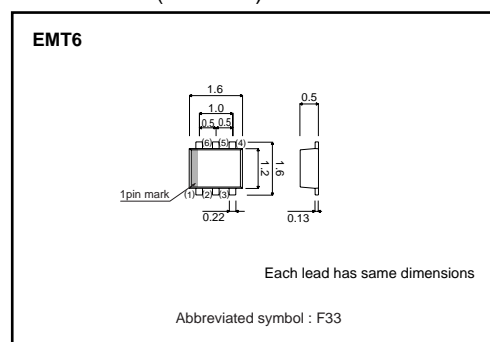
\*  $PW \leq 10ms$  DUTY CYCLE  $\leq 50\%$

<Tr1, Tr2 in common>

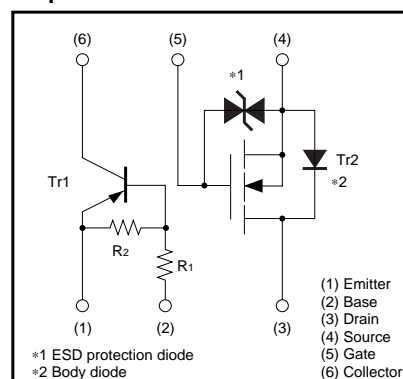
Parameter	Symbol	Limits	Unit
Power dissipation	$P_D$ *	150	mW / TOTAL
		120	mW / ELEMENT
Junction temperature	$T_j$	150	°C
Range of storage temperature	$T_{stg}$	-55 to +150	°C

\* Each terminal mounted on a recommended land.

### ●Dimensions (Unit : mm)



### ●Equivalent circuit



Tr1 :  $R_1/R_2=1k\Omega/10k\Omega$   
Tr2 : MOS FET

## Transistors

## ●Electrical characteristics (Ta=25°C)

&lt;Tr1&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Input voltage	$V_{I(off)}$	–	–	–0.3	V	$V_{CC} = -5V, I_O = -100\mu A$
	$V_{I(on)}$	–2.5	–	–	V	$V_O = -0.3V, I_O = -20mA$
Output voltage	$V_{O(on)}$	–	–60	–300	mV	$V_O = -100mA, I_I = -5mA$
Input current	$I_I$	–	–	–6.4	mA	$V_I = -5V$
Output current	$I_{O(off)}$	–	–	–0.5	uA	$V_{CC} = -12V, V_I = 0V$
DC current gain	$G_I$	140	–	–	–	$V_O = -5V, I_O = -100mA$
Transition frequency	$f_T$ *	–	260	–	–	$V_{CE} = -10V, I_E = 5mA, f = 100MHz$
Input resistance	$R_1$	0.7	1	1.3	k $\Omega$	
Resistance ratio	$R_2/R_1$	8	10	12	–	

\* Characteristics of built-in transistor.

&lt;Tr2&gt;

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	–	–	$\pm 1$	$\mu A$	$V_{GS} = \pm 20V, V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	30	–	–	–	$I_D = 10\mu A, V_{GS} = 0A$
Zero gate voltage drain current	$I_{DSS}$	–	–	1.0	$\mu A$	$V_{DS} = 30V, V_{GS} = 0V$
Gate-threshold voltage	$V_{GS(th)}$	0.8	–	1.5	V	$V_{DS} = 3V, I_D = 100\mu A$
Static drain-source on-resistance	$R_{DS(on)}$	–	5	8	$\Omega$	$I_D = 10mA, V_{GS} = 4V$
		–	7	13	$\Omega$	$I_D = 1mA, V_{GS} = 2.5V$
Forward transfer admittance	$ Y_{fs} $	20	–	–	ms	$V_{DS} = 3V, I_D = 10mA$
Input capacitance	$C_{iss}$	–	13	–	pF	$V_{DS} = 5V$
Output capacitance	$C_{oss}$	–	9	–	pF	$V_{GS} = 0V$
Reverse transfer capacitance	$C_{rss}$	–	4	–	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}$	–	15	–	ns	$I_D = 10mA$
Rise time	$t_r$	–	35	–	ns	$V_{DD} = 5V$
Turn-off delay time	$t_{d(off)}$	–	80	–	ns	$V_{GS} = 5V$
		–	80	–	ns	$R_L = 500\Omega$
Fall time	$t_f$	–	80	–	ns	$R_{GS} = 10\Omega$

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